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From: Jacqueline J. Garner
Texas Instruments Incorporated
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: West et al.

Art Unit: 2822

Serial No.: 10/697,137

Examiner: Guerrero, M.

Filing Date: 10/30/2003

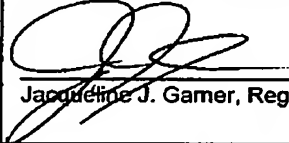
Docket No.: TI-36238

Customer No.: 23494

Conf. No.: 9756

Title: METHOD FOR IMPROVING RELIABILITY OF COPPER INTERCONNECTS

CERTIFICATION OF FACSIMILE TRANSMISSION

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NAME OF INVENTOR(S): WEST	
TITLE OF INVENTION: METHOD FOR IMPROVING . . .	
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Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75074